

10 AMP SILICON BRIDGE RECTIFIERS

ACTUAL SIZE

FEATURES

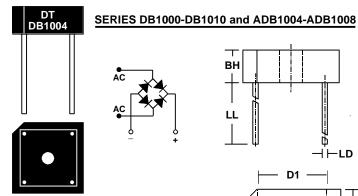
- PRV Ratings from 50 to 1000 Volts •
- Surge overload rating to 150 Amps peak
- Reliable low cost molded plastic construction
- Ideal for printed circuit board applications

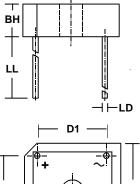
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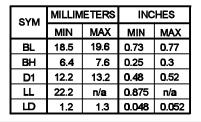
MECHANICAL DATA

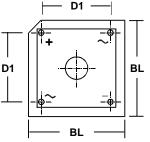
- Case: Molded plastic, U/L Flammability Rating 94V-0 •
- Terminals: Round silver plated copper pins ٠
- Soldering: Per MIL-STD 202 Method 208 guaranteed
- Polarity: Marked on side of case; positive lead at beleveled corner
- Mounting Position: Any. Through hole provided for #6 screw
- Weight: 0.18 Ounces (5.4 Grams) •

MECHANICAL SPECIFICATION









MAXIMUM RATINGS & ELECTRICAL CHARACTERISTICS

Ratingsat25°Cambienttemperature unlessotherwisespecified. Single phase, half wave, 60Hz, resistive or inductive load.

PARAMETER (TEST CONDITIONS)	SYMBOL	RATINGS										
		CONTROLLED NON-CONTROLLED AVALANCHE AVALANCHE										
Series Number		ADB 1004	ADB 1006	ADB 1008	DB 1000	DB 1001	DB 1002	DB 1004	DB 1006	DB 1008	DB 1010	
Maximum DC Blocking Voltage	Vrm										1000	
Working Peak Reverse Voltage	Vrwm							400				
Maximum Peak Recurrent Reverse Voltage	Vrrm											
RMS Reverse Voltage	VR (RMS)	280	420	560	35	70	140	280	420	560	700	
Power Dissipation in V(BR) Region for 100 μS Square Wave	Ркм	500			n/a							
Continuous Power Dissipation in V(BR) Region @ THs=80 °C (Heat Sink Temp)	Pr	2 n/a								WATT		
Thermal Energy (Rating for Fusing)	l²t	64									AMPS SEC	
Peak Forward Surge Current (8.3 mSec single half sine wave superimposed on rated load)	IFSM	150										AMPS
Average Forward $@$ Tc = 50 °C (Note 1)Rectified Current $@$ Tc = 100 °C (Note 1); TA = 50 °C (Note 2)	lo	10 8										
Junction Operating and Storage Temperature Range	TJ, TSTG	-55 to +150								°C		
Minimum Avalanche Voltage	V(BR) Min	450 650 850 n/a						VOLTS				
Maximum Avalanche Voltage	V(BR) Max	900 1100 1300 n/a										
Maximum Forward Voltage (Per Diode) at 5 Amps DC	Vfm	1.1							1			
Maximum Reverse Current at Rated VRM @ TA = 25°C @ TA = 100°C	IRM	5								μ Α mA		
Minimum Insulation Breakdown Voltage (Circuit to Case)	Viso	2000										VOLT
Typical Thermal Resistance (on Heat Sink) Junction to Ambient Junction to Case	RθJA RθJC	2.5 5.0									°C/W	

NOTES: (1) Unit Mounted on Metal Chassis

(2) Unit Mounted on PC Board



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RATING & CHARACTERISTIC CURVES FOR SERIES DB1000 - DB1010 and SERIES ADB1004 - ADB1008

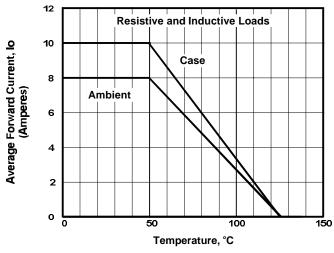


FIGURE 1. FORWARD CURRENT DERATING CURVE

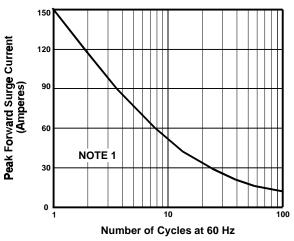
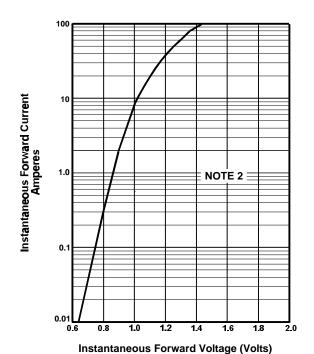
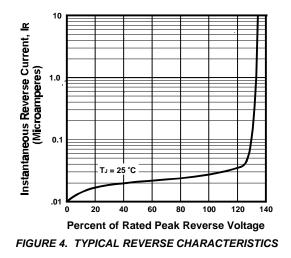


FIGURE 2. MAXIMUM NON-REPETITIVE SURGE CURRENT





4.97bbrdb800

FIGURE 3. TYPICAL FORWARD CHARACTERISTIC PER DIODE

NOTES (1) JEDEC Method, 8.3 mSec. Single Half Sine Wave; TJ = 125 °C

(2) TJ = 25 °C; Pulse Width = 300 μ Sec